
MSC7165

16-Bit Grid Driver with 4 to 16-Decoder

GENERAL DESCRIPTION

The MSC7165 is a driver IC designed to directly drive the grids of a vacuum fluorescent display tube.

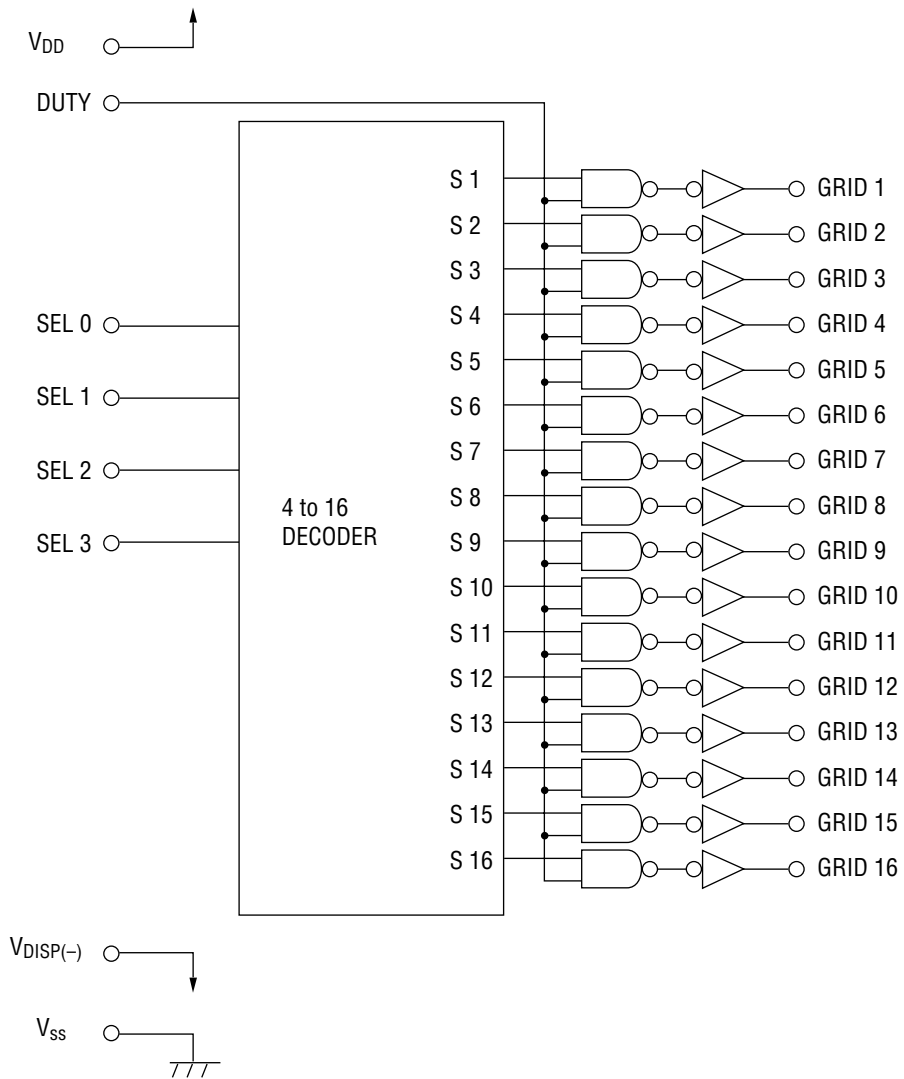
Since this IC has a built-in 4 to 16-line decoder and 16 output circuits, a single device of MSC7165 can replace a set of the following three: two devices of either MSL915 or MSL917 and one device of either MSM4514 or MSM74HC4514.

Setting the DUTY pin to the "L" level makes all driver outputs go "L". Blanking can be set using this function.

FEATURES

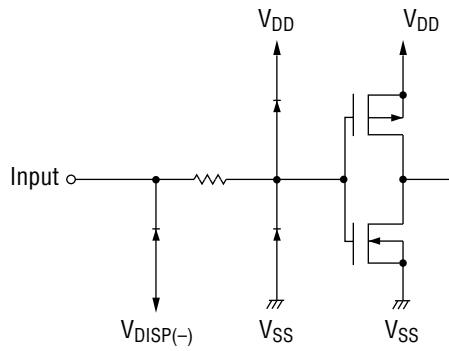
- Logic supply voltage : 5V
- Driver supply voltage : -60V
- Driver output current
 - I_{OH} : -40mA
 - I_{OL} : 1mA
- Can be connected directly to VFD without a pull-down resistor
- Built-in 4 to 16-line decoder
- Brightness can be adjusted by the DUTY pin
- Package:
 - 24-pin plastic SOP (SOP24-P-430-1.27-K) (Product name: MSC7165GS-K)

BLOCK DIAGRAM

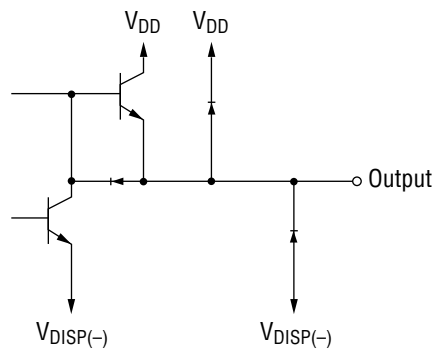


INPUT AND OUTPUT CONFIGURATION

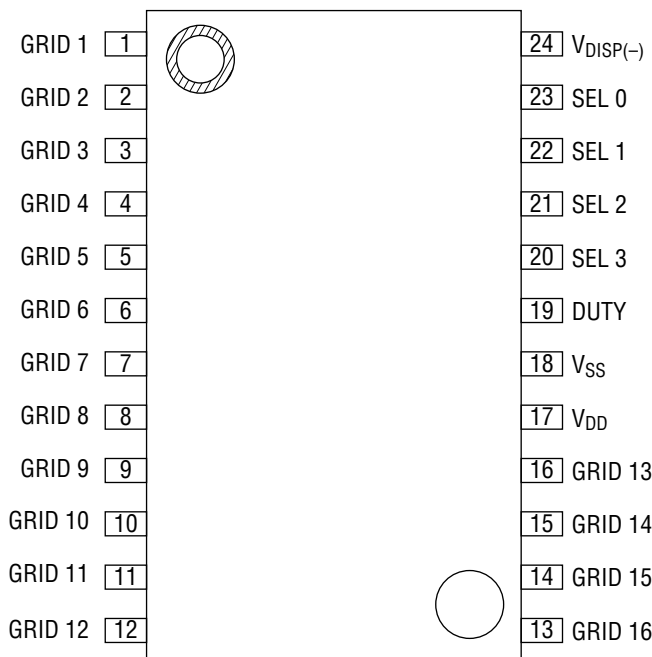
Schematic Diagrams of Logic Portion Input Circuit



Schematic Diagram of Driver Output Circuit



PIN CONFIGURATION (TOP VIEW)



24-Pin Plastic SOP

PIN DESCRIPTIONS

| Symbol | Type | Description |
|----------------------|------|---|
| SEL0-3 | I | 4- to 16-line decoder input pins The input 4-bit binary signals are converted into hexadecimal signals, then output through driver output pins. |
| DUTY | I | Duty control signal input pin Setting this pin to "L" makes all driver outputs go "L", so this pin can be used for brightness control. |
| GRID1-16 | O | High withstand voltage driver output pins for driving fluorescent display tube These pins can be connected directly to the grid of fluorescent display tube. No pull-down resistor is required. |
| V _{DISP(-)} | — | Power supply pin for the fluorescent display tube driver circuit |
| V _{DD} | — | Logic power supply pin |
| V _{SS} | — | Ground pin |

ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Condition | Rating | Unit |
|----------------------------|---------------|------------------------------|--------------------------|--------------------|
| Logic Supply Voltage | V_{DD} | Applied to logic supply pin | -0.3 to +6.5 *1 | V |
| Driver Supply Voltage | $V_{DISP(-)}$ | Applied to driver supply pin | -70 to V_{DD} *1 *2 | V |
| Input Voltage | V_{IN} | Applied to all input pins | -0.3 to $V_{DD}+0.3$ *1 | V |
| Power Dissipation | P_D | $T_a \leq 25^\circ\text{C}$ | 790 | mW |
| Package Thermal Resistance | R_{j-a} | — | 158 *3 | $^\circ\text{C/W}$ |
| Storage Temperature | T_{STG} | — | -55 to +150 | $^\circ\text{C}$ |

*1 The maximum supply voltage for V_{SS}

*2 Permanent damage to the device may be caused if the voltage is supplied over the absolute maximum rating value.

*3 Thermal resistance of the package (between junction and atmosphere)

The junction temperature (T_j) given by the equation indicated below should not exceed 150°C .

$$T_j = P \times R_{j-a} + T_a \quad (P: \text{Maximum power consumption of IC})$$

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Condition | Min. | Max. | Unit |
|---------------------------|---------------|-----------------------------------|------|------|------------------|
| Logic Supply Voltage | V_{DD} | Applied to logic supply pin | 4.5 | 5.5 | V |
| Driver Supply Voltage | $V_{DISP(-)}$ | Applied to driver supply pin | -60 | -5 | V |
| High Level Input Voltage | V_{IH} | Applied to all input pins | 3.1 | — | V |
| Low Level Input Voltage | V_{IL} | Applied to all input pins | — | 1.7 | V |
| High Level Output Current | I_{OH} | Applied to all driver output pins | — | -40 | mA |
| Low Level Output Current | I_{OL} | Applied to all driver output pins | — | 1.0 | mA |
| Operating Temperature | T_{op} | — | -40 | 85 | $^\circ\text{C}$ |
| Input Pulse Rise time | t_r | Applied to all input pins | — | 1.0 | μs |
| Input Pulse Fall Time | t_f | Applied to all input pins | — | 1.0 | μs |

ELECTRICAL CHARACTERISTICS

DC Characteristics

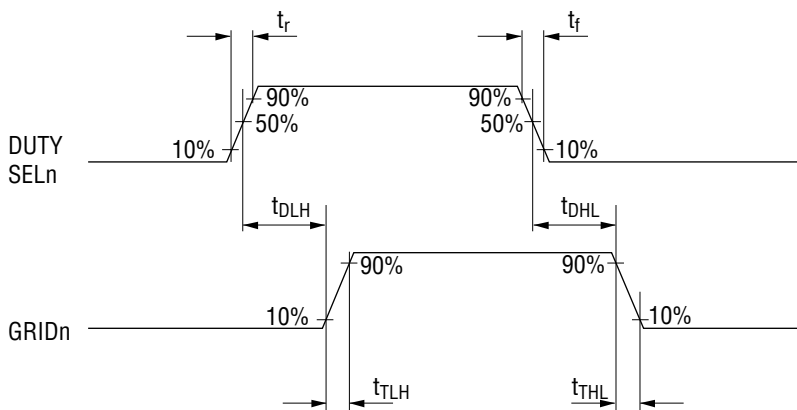
($V_{DD}=4.5$ to $5.5V$, $V_{DISP(-)}=-60$ to $-5V$, $T_a=-40$ to $+85^{\circ}C$)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|---------------------------|-------------|---------------------|------------|------|-------------------|---------|
| Logic Supply Voltage | I_{DD1} | No load, 1 output H | — | — | 6.0 | mA |
| | I_{DD2} | No load, DUTY=L | — | — | 6.0 | mA |
| Driver Supply Voltage | I_{DISP1} | No load, 1 output H | -6.0 | — | — | mA |
| | I_{DISP2} | No load, DUTY=L | -6.0 | — | — | mA |
| High Level Input Current | I_{IH} | — | — | — | ± 1 | μA |
| Low Level Input Current | I_{IL} | — | — | — | ± 1 | μA |
| High Level Output Voltage | V_{OH} | $I_{OH}=-40mA$ | $V_{DD}-4$ | — | — | V |
| Low Level Output Voltage | V_{OL} | $I_{OL}=1mA$ | — | — | $V_{DISP(-)}+2.5$ | V |

AC Characteristics

($V_{DD}=4.5$ to $5.5V$, $V_{DISP(-)}=-60$ to $-5V$, $T_a=-40$ to $+85^{\circ}C$)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|-----------------------|-----------|-------------------------------|------|------|------|---------|
| Delay Time L to H | t_{DLH} | $C_L=10pF$, See figure below | — | 0.5 | 1.5 | μs |
| Transient Time L to H | t_{TLH} | $C_L=10pF$, See figure below | — | 2.0 | 4.0 | μs |
| Delay Time H to L | t_{DHL} | $C_L=10pF$, See figure below | — | 0.3 | 1.0 | μs |
| Transient Time H to L | t_{THL} | $C_L=10pF$, See figure below | — | 2.0 | 4.0 | μs |



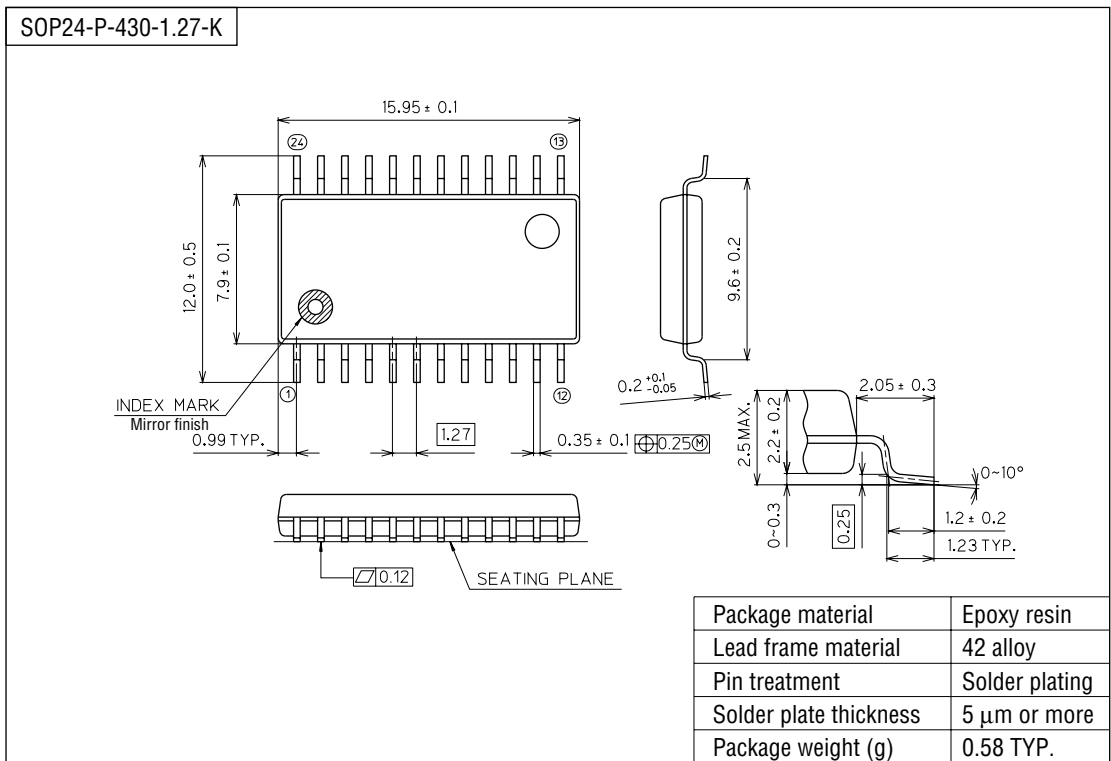
FUNCTIONAL DESCRIPTION

Function Table

| DUTY | SEL | | | | GRID | | | | | | | | | | | | | | | |
|----------|-----|---|---|---|------|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|
| | 0 | 1 | 2 | 3 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 |
| L | X | X | X | X | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| | L | L | L | L | H | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| H | H | L | L | L | L | H | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| | L | H | L | L | L | L | H | L | L | L | L | L | L | L | L | L | L | L | L | L |
| | H | H | L | L | L | L | L | H | L | L | L | L | L | L | L | L | L | L | L | L |
| | L | L | H | L | L | L | L | L | H | L | L | L | L | L | L | L | L | L | L | L |
| | H | L | H | L | L | L | L | L | L | H | L | L | L | L | L | L | L | L | L | L |
| | L | H | H | L | L | L | L | L | L | L | H | L | L | L | L | L | L | L | L | L |
| | H | H | H | L | L | L | L | L | L | L | L | H | L | L | L | L | L | L | L | L |
| | L | L | L | H | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L |
| | H | L | L | H | L | L | L | L | L | L | L | L | L | L | H | L | L | L | L | L |
| | L | H | L | H | L | L | L | L | L | L | L | L | L | L | H | L | L | L | L | L |
| | H | H | L | H | L | L | L | L | L | L | L | L | L | L | L | H | L | L | L | L |
| | L | L | H | H | L | L | L | L | L | L | L | L | L | L | L | L | H | L | L | L |
| | H | L | H | H | L | L | L | L | L | L | L | L | L | L | L | L | L | H | L | L |
| | L | H | H | H | L | L | L | L | L | L | L | L | L | L | L | L | L | L | H | L |
| | H | H | H | H | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L | L |

PACKAGE DIMENSIONS

(Unit : mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, SOJ, QFJ (PLCC), SHP and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).